

E

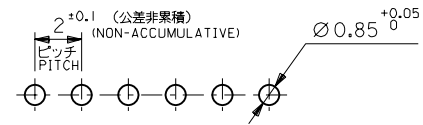
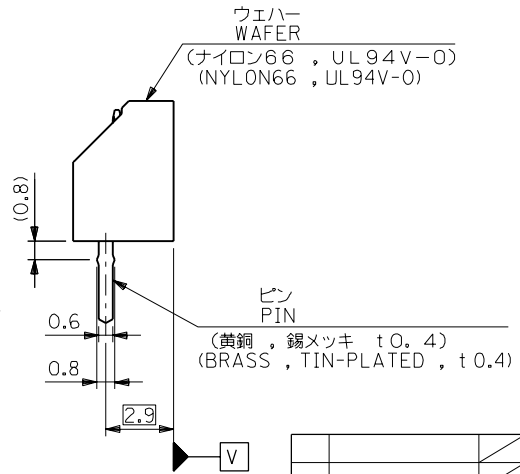
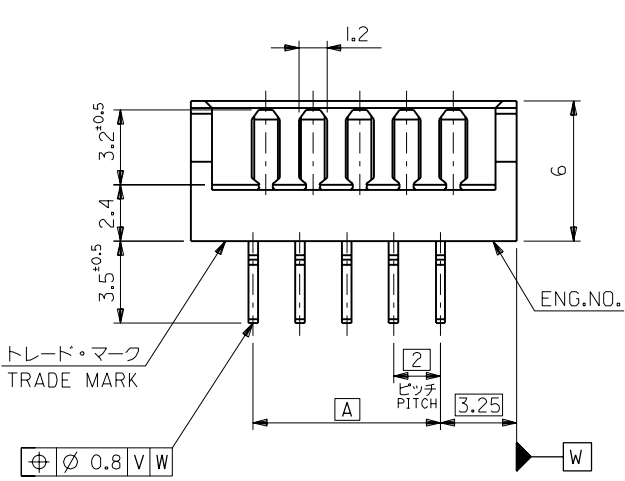
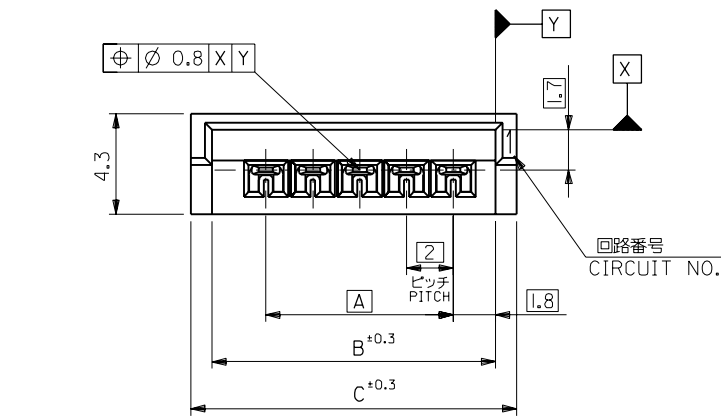
D

C

B

A

MM DIMENSIONS IN METRIC DO NOT SCALE DRAWING



基板取付穴推奨寸法
RECOMMENDED P.C. BOARD HOLE DIM.

注記
NOTES

1. 嵌合相手 : 5513-NAPB, 5513-NCPB
MATES WITH 5513-NAPB, 5513-NCPB
2. メス側との基板取付穴のスレについては図面 SD-5513-NCPB を参照のこと。
REFER TO SD-5513-NCPB FOR P.C. BOARDS POSITIONING DIMENSIONS.

| | | | | | |
|------|------|----|------------|------------|------------|
| 43.9 | 42.1 | 38 | 39-26-9206 | 5512 - 20A | 20 |
| 41.9 | 40.1 | 36 | - 9196 | - 19A | 19 |
| 39.9 | 38.1 | 34 | - 9186 | - 18A | 18 |
| 37.9 | 36.1 | 32 | - 9176 | - 17A | 17 |
| 35.9 | 34.1 | 30 | - 9166 | - 16A | 16 |
| 33.9 | 32.1 | 28 | - 9156 | - 15A | 15 |
| 31.9 | 30.1 | 26 | - 9146 | - 14A | 14 |
| 29.9 | 28.1 | 24 | - 9136 | - 13A | 13 |
| 27.9 | 26.1 | 22 | - 9126 | - 12A | 12 |
| 25.9 | 24.1 | 20 | - 9116 | - 11A | 11 |
| 23.9 | 22.1 | 18 | - 9106 | - 10A | 10 |
| 21.9 | 20.1 | 16 | - 9096 | - 09A | 9 |
| 19.9 | 18.1 | 14 | - 9086 | - 08A | 8 |
| 17.9 | 16.1 | 12 | - 9076 | - 07A | 7 |
| 15.9 | 14.1 | 10 | - 9066 | - 06A | 6 |
| 13.9 | 12.1 | 8 | - 9056 | - 05A | 5 |
| 11.9 | 10.1 | 6 | - 9046 | - 04A | 4 |
| 9.9 | 8.1 | 4 | - 9036 | - 03A | 3 |
| 7.9 | 6.1 | 2 | 39-26-9026 | 5512 - 02A | 2 |
| C | B | A | EDP NO. | ENG. NO. | 極致 CKT. |

| | | | | | |
|----------------------------|-------|-----------|--------------------------|-------------|------------|
| 角度 ANGLE | ±3° | | | | |
| 30 以上 OVER | +0.3 | | | | |
| 10 以上 30 未満 OVER UNDER | +0.25 | | | | |
| 10 未満 UNDER | +0.2 | | | | |
| 一般公差 GENERAL TOLERANCES | | 記号 LTR | 変更内容 REVISION RECORD | DR. CHK. | 日付 DATE |
| | | D | 再作図 REDRAWN (JC60160) | T.YASUI | '95/9/14 |
| | | | | M.FUKUSHIMA | '95/9/14 |

| | |
|----------------------------------|-------------------------------------|
| 材料 MATERIAL | 図中参照 DESCRIBED IN THE DRAWING |
| 仕上げ FINISH | — |
| 適用電線範囲 WIRE RANGE | — |
| 被覆外径 INS. RANGE | — |
| DRAWN BY '95/9/14 T.YASUI | CHK'D BY '95/9/14 H.HIRAMOTO |
| APP'D BY '95/9/14 M.FUKUSHIMA | 尺度 SCALE 5 : 1 |

| | |
|--|----------|
| molex MOLEX-JAPAN CO.,LTD. 日本モレックス株式会社 | |
| REVISE ONLY ON CAD SYSTEM | |
| TITLE 名称 2.0 BOARD TO BOARD CONN. WAFER ASSY | |
| DWG. NO. SD-5512-NA | REV D |